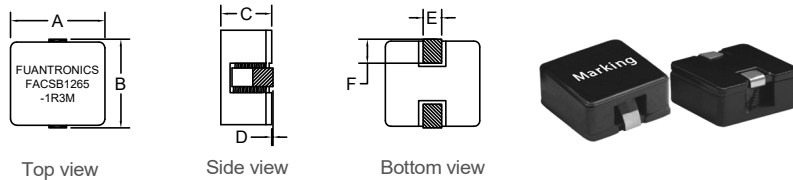


P/N: FACSB1265-1R3M

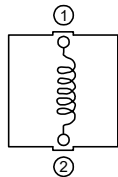


Outline Dimensions(Unit:mm)

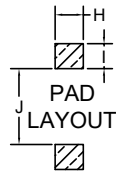


A	B	C	D	E	F
±0.50	±1.00	±0.30		±0.50	±1.00
12.8	13.0	6.20	0-0.2	2.50	3.00

Electronical Schematic



Suggested Pad layout



H	5.50 REF
I	4.50 REF
J	6.00 REF

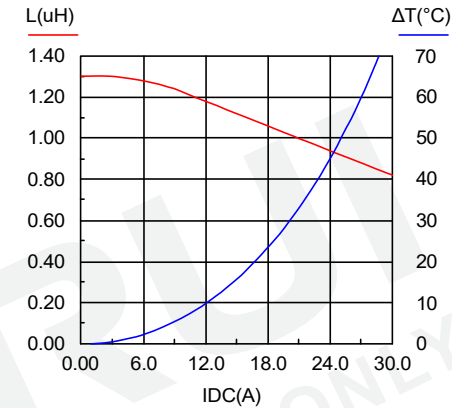
- ***Magnetic shielded structure: excellent resistance to electro magnetic interferenc(EMI).
- ***Flat wire winding, achieve a low D.C. Resistance.
- ***Low loss, high efficiency, wide application frequency and application scope.
- ***Lightweight design, save space, suitable for high density SMT.

Electrical Characteristics(@25°C)

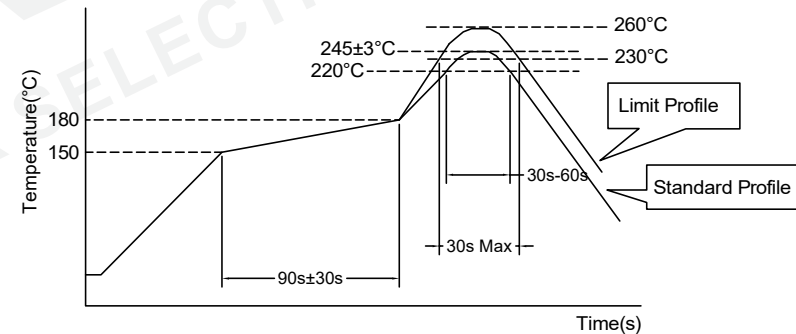
Inductance 100KHz,0.1V	DC Resistor	Saturated current 25A	Temperature rise current 25A
1.30uH±20%	2.00mΩ Max	L(25A)=70%*L0A Typ	T≤50°C Typ

- ***Saturation current: the actual value of DC current when the inductance decrease 30% of its initial value.
- ***Temperature rise current: the actual value of DC current when the temperature rise is ΔT50°C(Ta=25°C).
- ***Operating Temperature: -40°C~+125°C.
(Temperature rise included)
- ***Storage Temperature: -40°C~+125°C.
- ***Storage Humidity:RH10%~70%.

Saturation current VS temperature rise current curve:



Recommended Soldering Temperature Graph.



	Standard Profile	Standard Profile
Pre-heating	150~180°C, 90s±30s	
Heating	above 220°C, 30s-60s	above 240°C, 30s Max
Peak temperature	245°C±3°C	260°C, 10s
Cycle of reflow	2 times	2 times

REV	DESCRIPTION	APPD	DATE	<p>Tianchang Fuan Electronic Co Ltd www.fuantronics.net TEL: +86-550-7814888 FAX: +86-550-7831133</p>	<p>Tolerances unless otherwise specified: (.X)±0.50 (.XX)±0.25 Unit of measurement: mm</p>	<p>Make: Qiumei.Liu</p> <p>Checked: Beson. zhan</p> <p>Approved: Anson. zhan</p>	<p>DRAWING TITLE HIGH CURRENT POWER INDUCTORS</p> <p>Material Number: A341265XS030</p>	<p>Customer Name:</p> <p>Document/Rev: 00</p> <p>Specification Sheet: 1 of 1</p> <p>Date of Recognition: Jan./02/2020</p>